

## SURFACE MOUNT ULTRAFAST RECTIFIER VOLTAGE 50 to 1000 Volt CURRENT 2 Ampere

### Features

- For surface mounted applications in order to optimize board space
- Easy pick and place
- Plastic package has Underwriters Laboratory Flammability
- Classification 94V-O
- Low Forward Drop
- High temperature soldering : 260°C /10 seconds at terminals
- Glass Passivated Chip Junction
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. . (Halogen Free)
- AEC-Q101 qualified (Automotive grade with suffix "Q".)
- Exsemi technology



### Mechanical Data

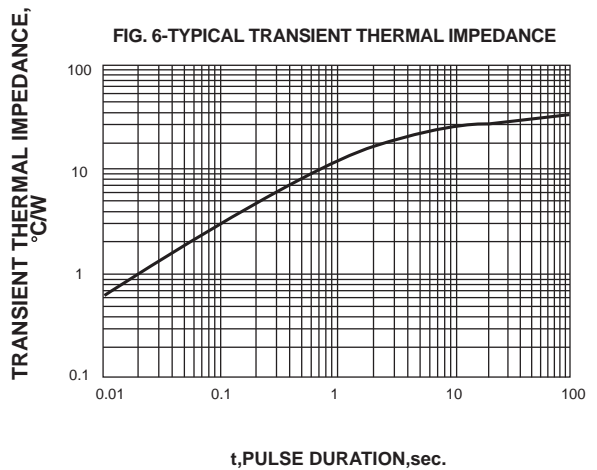
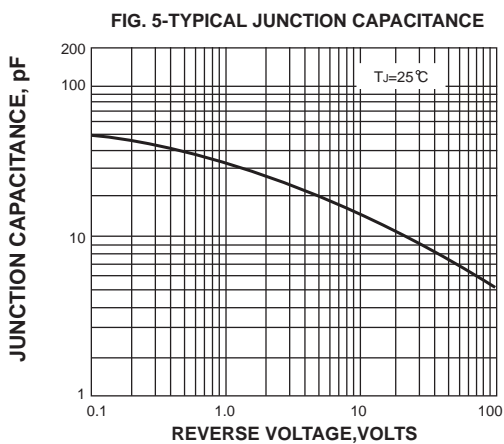
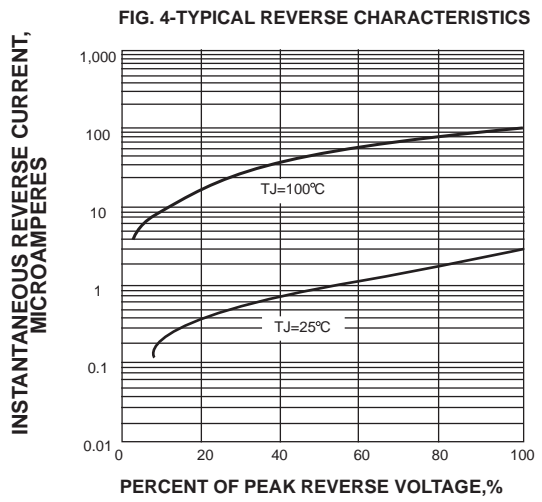
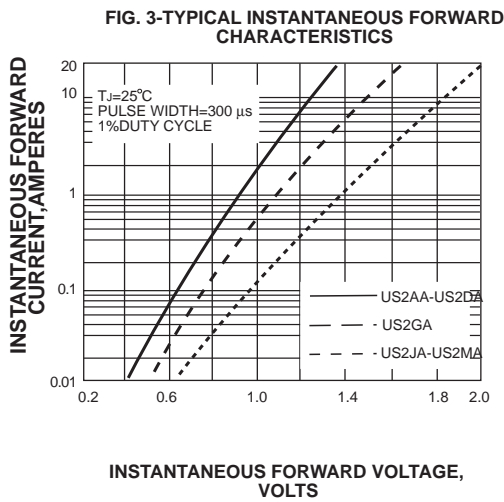
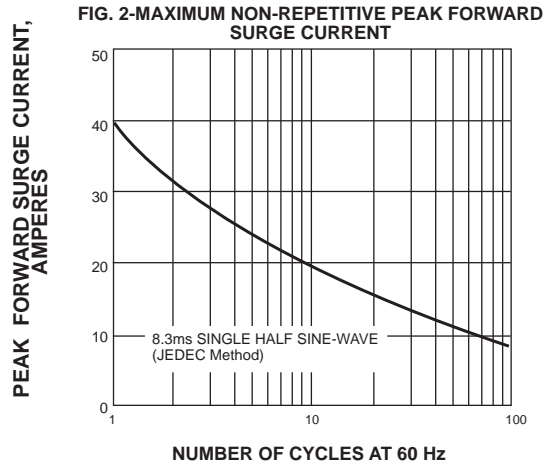
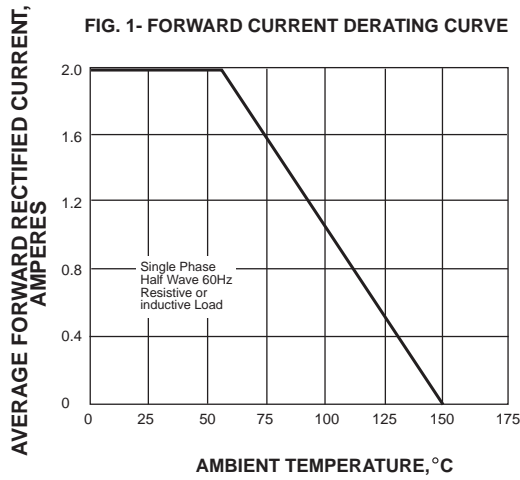
- Case: JEDEC DO-214AC molded plastic
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Standard packaging: 12mm tape (EIA-481)
- Weight: 0.002 ounce, 0.067 gram

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

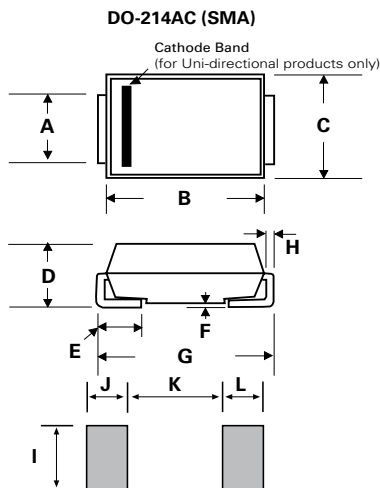
Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Catalog Number	SYMBOLS	US2AA	US2BA	US2DA	US2GA	US2JA	US2KA	US2MA	UNITS
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	VOLTS
Maximum average forward rectified current at $T_L=75^\circ\text{C}$	$I_{(AV)}$	2.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	40.0							Amps
Maximum instantaneous forward voltage at 2.0A	$V_F$	1.0		1.4	1.7			Volts	
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=125^\circ\text{C}$	$I_R$	5.0 350.0							$\mu\text{A}$
Maximum reverse recovery time (NOTE 1)	$t_{rr}$	50				75			ns
Typical junction capacitance (NOTE 2)	$C_J$	28.0							pF
Typical thermal resistance (NOTE 3)	$R_{\theta JL}$ $R_{\theta JA}$	25.0 55.0							$^\circ\text{C}/\text{W}$
Operating junction and storage temperature range	$T_J, T_{STG}$	-50 to +150							$^\circ\text{C}$

- NOTES: 1. Measured at 1 MHz and applied  $V_R = 4$  volts.  
2. Mounted on a FR4 PCB, single-sided copper, with 100cm<sup>2</sup> copper pad area  
3. Mounted on a FR4 PCB, single-sided copper, mini pad.



Dimensions

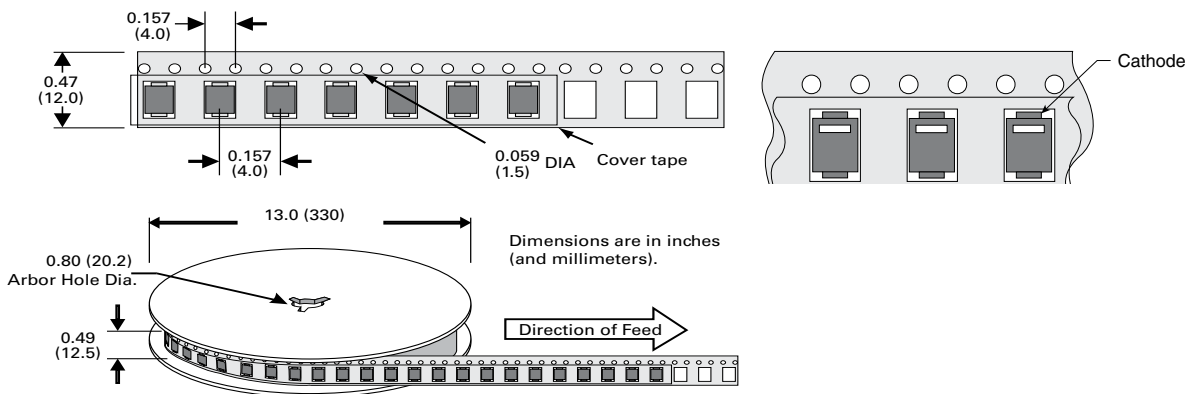


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.047	0.067	1.200	1.700
B	0.154	0.185	3.900	4.700
C	0.095	0.114	2.400	2.900
D	0.075	0.096	1.900	2.440
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.185	0.222	4.700	5.660
H	0.006	0.012	0.152	0.305
I	0.066	-	1.680	-
J	0.068	-	1.720	-
K	-	0.090	-	2.300
L	0.068	-	1.720	-

Ordering Information

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
US2XA	DO-214AC	5000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

Tape and Reel Specication



Note: Devices are packde in accordance with EIA standard RS-481-Aand specification given above.